

Vishay Semiconductors

Fast Avalanche Sinterglass Diode

Features

- · Glass passivated junction
- · Hermetically sealed package
- Lead (Pb)-free component
- Component in accordance to RoHS 2002/95/EC and WEEE 2002/96/EC



Applications

High voltage fast rectification diode

949539

Mechanical Data

Case: SOD-57 Sintered glass case

Terminals: Plated axial leads, solderable per

MIL-STD-750, Method 2026

Polarity: Color band denotes cathode end

Mounting Position: Any **Weight:** approx. 369 mg

Parts Table

Part	Type differentiation	Package		
BY268	V _R = 1400 V; I _{FAV} = 0.8 A	SOD-57		
BY269	V _R = 1600 V; I _{FAV} = 0.8 A	SOD-57		

Absolute Maximum Ratings

T_{amb} = 25 °C, unless otherwise specified

Parameter	Test condition	Part	Symbol	Value	Unit
Peak reverse voltage, non repetitive		BY268	V _{RSM}	1600	V
		BY269	V _{RSM}	1800	V
Reverse voltage	see electrical characteristics	BY268	V _R	1400	V
		BY269	V _R	1600	V
Peak forward surge current	t _p = 10 ms, half sinewave		I _{FSM}	20	Α
Average forward current			I _{FAV}	0.8	Α
Junction and storage temperature range			$T_j = T_{stg}$	- 55 to + 175	°C
Non repetitive reverse avalanche energy	I _{(BR)R} = 0.4 A		E _R	10	mJ

Maximum Thermal Resistance

T_{amb} = 25 °C, unless otherwise specified

De versete v	To at a smallting	Davit	Company of	Value	I Inch
Parameter	Test condition	Part	Symbol	Value	Unit
Junction ambient	on PC board with spacing 25 mm		R_{thJA}	100	K/W
	L = 10 mm, T _L = constant		R _{thJA}	45	K/W

Document Number 86005 www.vishay.com

Rev. 1.6, 13-Apr-05

Vishay Semiconductors



Electrical Characteristics

 T_{amb} = 25 °C, unless otherwise specified

Parameter	Test condition	Part	Symbol	Min	Тур.	Max	Unit
Forward voltage	I _F = 0.4 A		V_{F}			1.25	V
Reverse current	V _R = 1400 V	BY268	I _R		1	2	μΑ
	V _R = 1600 V	BY269	I _R		1	2	μΑ
	V _R = 1400 V, T _j = 100 °C	BY268	I _R			15	μΑ
	V _R = 1600 V, T _j = 100 °C	BY269	I _R			15	μΑ
Reverse recovery time	I _F = 0.5 A, I _R = 1 A, i _R = 0.25 A		t _{rr}			400	ns

Typical Characteristics (Tamb = 25 °C unless otherwise specified)

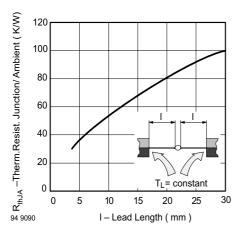


Figure 1. Typ. Thermal Resistance vs. Lead Length

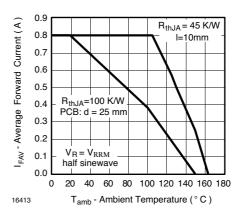


Figure 3. Max. Average Forward Current vs. Ambient Temperature

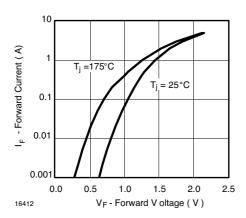


Figure 2. Forward Current vs. Forward Voltage

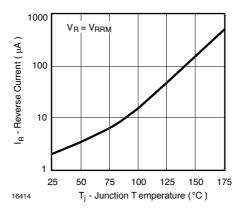


Figure 4. Reverse Current vs. Junction Temperature



Vishay Semiconductors

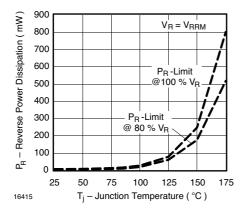


Figure 5. Max. Reverse Power Dissipation vs. Junction Temperature

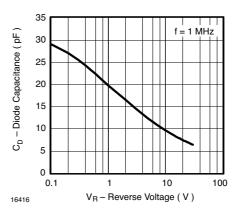
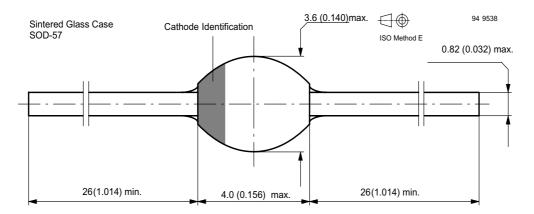


Figure 6. Diode Capacitance vs. Reverse Voltage

Package Dimensions in mm (Inches)



BY268 / BY269

Vishay Semiconductors



Ozone Depleting Substances Policy Statement

It is the policy of Vishay Semiconductor GmbH to

- 1. Meet all present and future national and international statutory requirements.
- 2. Regularly and continuously improve the performance of our products, processes, distribution and operating systems with respect to their impact on the health and safety of our employees and the public, as well as their impact on the environment.

It is particular concern to control or eliminate releases of those substances into the atmosphere which are known as ozone depleting substances (ODSs).

The Montreal Protocol (1987) and its London Amendments (1990) intend to severely restrict the use of ODSs and forbid their use within the next ten years. Various national and international initiatives are pressing for an earlier ban on these substances.

Vishay Semiconductor GmbH has been able to use its policy of continuous improvements to eliminate the use of ODSs listed in the following documents.

- 1. Annex A, B and list of transitional substances of the Montreal Protocol and the London Amendments respectively
- 2. Class I and II ozone depleting substances in the Clean Air Act Amendments of 1990 by the Environmental Protection Agency (EPA) in the USA
- 3. Council Decision 88/540/EEC and 91/690/EEC Annex A, B and C (transitional substances) respectively.

Vishay Semiconductor GmbH can certify that our semiconductors are not manufactured with ozone depleting substances and do not contain such substances.

> We reserve the right to make changes to improve technical design and may do so without further notice.

Parameters can vary in different applications. All operating parameters must be validated for each customer application by the customer. Should the buyer use Vishay Semiconductors products for any unintended or unauthorized application, the buyer shall indemnify Vishay Semiconductors against all claims, costs, damages, and expenses, arising out of, directly or indirectly, any claim of personal damage, injury or death associated with such unintended or unauthorized use.

Vishay Semiconductor GmbH, P.O.B. 3535, D-74025 Heilbronn, Germany

www.vishay.com Document Number 86005 Rev. 1.6, 13-Apr-05